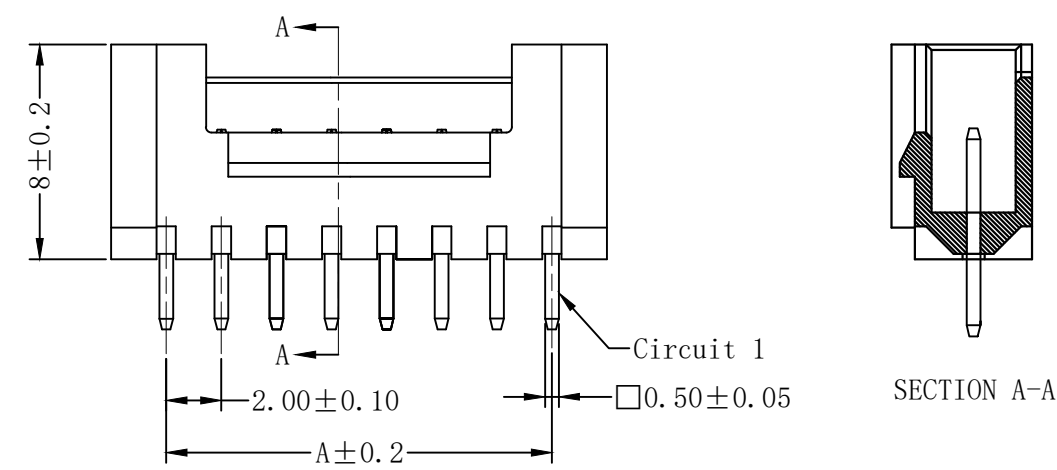
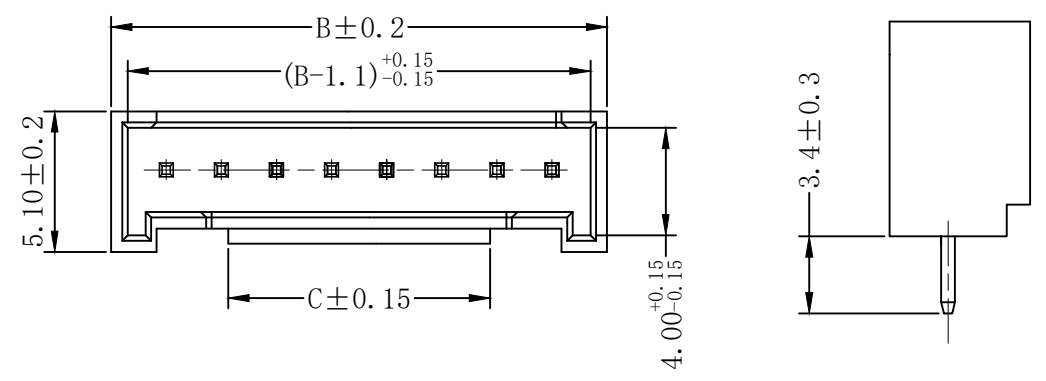
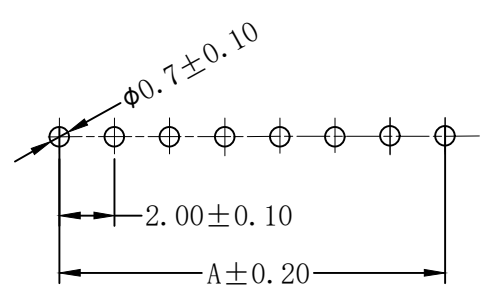


| REV. | DESCRIPTION | DATE |
|------|-------------|------|
| A/0 | 新版发行 | |
| | | |

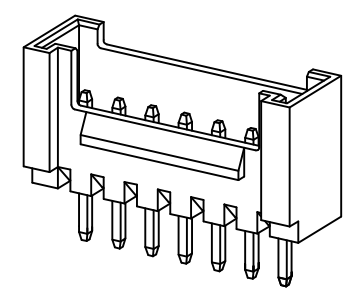
- 技术要求:
- 1、塑件材料: CM3004 (UL-94V-0)
 - 2、接触件: 黄铜镀锡
 - 3、接触电阻: $\leq 10m\Omega$
 - 4、绝缘电阻: $\geq 1000M\Omega$
 - 5、额定电压: 250V AC DC
 - 6、额定电流: 2.0A AC DC
 - 7、耐压: 能承受1000V AC/Minute
 - 8、工作温度: $-25^{\circ} \sim +85^{\circ}$
 - 9、可焊性试验: 浸锡面积 $\geq 95\%$ 温度 220^{+5}_{-0} , 时间 2.5 ± 0.5 秒
 - 10、铅和镉等六大有害物质含量要符合环保要求



| Circuits | Dimensions (mm) | | |
|----------|-----------------|-------|-------|
| | A | B | C |
| 02 | 2.00 | 6.10 | 2.50 |
| 03 | 4.00 | 8.00 | 2.50 |
| 04 | 6.00 | 10.00 | 3.50 |
| 05 | 8.00 | 12.00 | 5.50 |
| 06 | 10.00 | 14.00 | 7.50 |
| 07 | 12.00 | 16.00 | 9.50 |
| 08 | 14.00 | 18.00 | 11.50 |
| 09 | 16.00 | 20.00 | 13.50 |
| 10 | 18.00 | 22.00 | 15.50 |
| 11 | 20.00 | 24.00 | 15.50 |
| 12 | 22.00 | 26.00 | 15.50 |
| 13 | 24.00 | 28.00 | 15.50 |
| 14 | 26.00 | 30.00 | 15.50 |
| 15 | 28.00 | 32.00 | 15.50 |



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



| 序号 | 名称 | 材料 | 数量 | 附注 |
|----|------------|---------------|-------|---------------------------------|
| 2 | 端子 Contact | 黄铜 | n x 1 | 电镀层: 至少表面镀层30u"MIN, 厚度 80u"MIN. |
| 1 | 基板 Wafer | LCP (UL94V-0) | 1 | 绝缘 |

| GENERAL TOLERANCES | | | DRAWN BY 绘图者 | | 兆星精密电子 (深圳) 有限公司 | |
|--------------------|------------|-------------------------------|--------------|-----|------------------|------------------------|
| 0.X | ± 0.25 | $X^{\circ} \pm 3^{\circ}$ | CHK. BY | 审核者 | | |
| 0.XX | ± 0.12 | | APRV. BY | 批准人 | SHEET | PROD. NAME HY2.0 直针 4P |
| 0.XXX | ± 0.05 | $X.X^{\circ} \pm 0.5^{\circ}$ | DRAWING NO. | | 10F1 | PART NO. ZX-HY2.0-4PZZ |
| UNIT | SIZE | SCALE | TITLE | | | |
| MM | A4 | 1:1 | | | | |

借用登记

旧底图总号

底图总号

签字

日期